

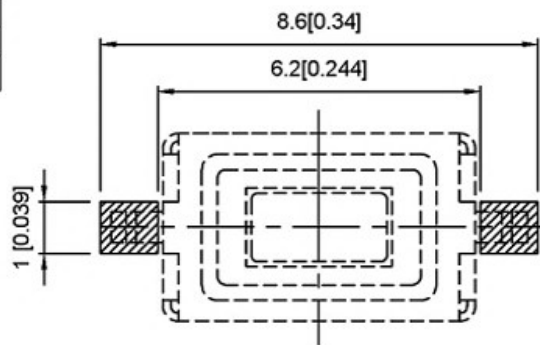
CIRCUIT DIAGRAM



⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Lcp		—
②	Cover	—	1	Brass	Plating Nickel	—
①	Keystake	—	1	Ppa		—
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

P.C.B MOUNTING PATTERN DIMENSION

The following soldering patterns are recommended for reflow soldering



SPECIFICATION

Contact Rating: 50mA,12V DC  
 Contact Resistance: 100mΩ max  
 Insulation Resistance: 100MΩ min.500V DC  
 Dielectric Strength: 250V AC/1minute  
 Travel: 0.25mm  
 Operating Temp: -30℃~+85℃  
 Storage Temp: -30℃~+80℃

PAPT NO	TS-1101-X-X
Operating Force	A:100gf B:160gf C:260gf
Height	H:2.5
Color	R:Red W:white

					units: mm	DSND		DATE		SCALE: N/A	MODEL TYPE: TACT SWITCH		
					tolerance:	DWN		DATE		VIEW:	PART NO.:		
					X.X ±0.2mm	CHKD		DATE		UNIT: mm/in	DWG NO.:		
					X.XX ±0.1mm	APPD		DATE		SIZE: A4	TS-1101-X-X		
					X.XXX ±0.05mm						WEIGHT	SHEET	REVISION
					UNSPECIFIED TOLERANCES	DONG GUAN XI BANG ELECTRONIC CO., LTD					1.0g	1/1	A0
REVISIONS													
MARK	DESCRIPTION	DATE	REVISED	APPROVED									
www.alpsr.com www.gdxjdz.com www.xbswitch.com													